



ConnectCore MP25

System-on-module

Hardware Reference Manual

Revision history—90002593

Revision	Date	Description
1P	August 2024	Initial draft.

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About the ConnectCore MP25

The Digi ConnectCore® MP25 System-on-Module (SOM) platform is a highly integrated, cost-effective, connected, secure embedded solution, built on the STM32MP2 MPU family. It integrates memory, power management, pre-certified wireless connectivity and advanced Digi TrustFence device security with a complete, open-source Linux software platform based on the Yocto Project.

Features and functionality

The ConnectCore MP25 system-on-module is based on the STM32MP2 processor from STMicroelectronics. This processor offers a number of interfaces, most of them multiplexed and not available simultaneously. The module has the following features:

- STM32MP2 ARM Cortex-A35:
 - Cortex-A35 operating at up to 1.5 GHz.
 - 32 KB L1 instruction cache.
 - 32 KB L1 data cache.
 - 512 KB unified level 2 cache.
 - Arm® NEON™ and Arm® TrustZone®
- Up to 1 GB, 16-bit DDR4 memory.
- Up to 8 GB, 8-bit eMMC flash memory.
- STPMIC25A Power Management IC (PMIC):
 - x7 adjustable buck SMPS converter.
 - x6 adjustable general purpose LDOs.
 - x1 DDR3L/DDR4/lpDDR/general purpose LDO.
 - x1 USB PHY LDO.
 - x1 reference voltage VREFDDR for DDR memory LDO.
- IEEE 802.11 a/b/g/n/ac/ax WLAN interface.
- Bluetooth version 5.4.
- Debug interfaces:
 - Arm® CoreSight™ trace and debug: SWD and JTAG interfaces
- STM32MP2 interfaces:
 - x8 I2C.
 - x3 I3C.
 - x4 UART.
 - x5 USART.
 - x1 low-power UART
 - x8 SPI, three I2Ss full-duplex master/slave.
 - x4 SAI.

- x1 SPDIF Rx.
- x3 SDMMC.
- x1 USB 2.0 Host with embedded Hi-Speed PHY.
- x1 USB 2.0/3.0 dual-role data with both Hi-Speed and SuperSpeed PHYs.
- x1 USB Type-C Power Delivery control with two CC lines PHY.
- x1 PCI Express with embedded 5 Gbits/s PHY (shared with USB 3.0 SuperSpeed).
- x3 FDCAN.
- x2 Gigabit Ethernet.
- x1 Gigabit Ethernet Switch connected to ETH1.
- x1 Flexible memory control (FMC) interface.
- x2 Octo-SPI Flash memory interface.
- x2 camera interfaces for CMOS sensors, one with ISP.
- x1 MIPI CSI camera interface.
- x1 LCD-TFT display controller.
- x1 MIPI DSI display interface.
- x1 LVDS display interface.

Safety instructions

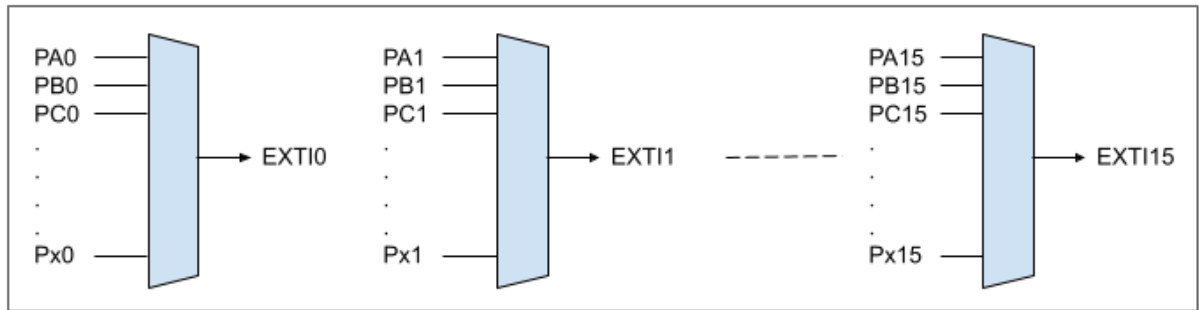
- The ConnectCore MP25 module cannot be guaranteed operation due to the radio link and so should not be used for interlocks in safety critical devices such as machines or automotive applications.
- The ConnectCore MP25 module has not been approved for use in (this list is not exhaustive):
 - nuclear applications
 - explosive or flammable atmospheres
- There are no user serviceable components inside the ConnectCore MP25 module. Do not modify the ConnectCore MP25 in any way. Modifications may exclude the module from any warranty and can cause the ConnectCore MP25 to operate outside of regulatory compliance for a given country, leading to the possible illegal operation of the radio.
- Use industry standard ESD protection when handling the ConnectCore MP25 module.
- Take care while handling to avoid electrical damage to the PCB and components.
- Do not expose ConnectCore MP25 module to water or moisture.
- Use this product with the antennas specified in the ConnectCore MP25 module user guides.

Limitations and notices

GPIO

The ConnectCore MP25 SoC has a limitation in the number of GPIOs that can be used as interrupt lines. The Extended Interrupt and Event Controllers (EXTI1 and EXTI2) can only handle up to 16 GPIO lines working as interrupt (EXTI0..EXTI15). The multiplexers work as shown in the following figure:

EXTI mux GPIO selection



This means that if pin 1 of two given ports (for instance, PB1 and PD1) have been selected to work as interrupt, pin 1 of any other GPIO port cannot simultaneously work as interrupt.

When designing your hardware, avoid using the same GPIO numbers as interrupt lines of three or more peripherals.

Latch-up

Latch-up is a condition that can cause excessive current draw and result in excessive heating of the microprocessor or its power supplies. This excessive heating can permanently damage the microprocessor and/or its supporting components.

The microprocessor used on this module, like all CMOS devices, can be driven into a latch-up condition if any I/O pin is driven outside of its associated power rail. Care must be taken to:



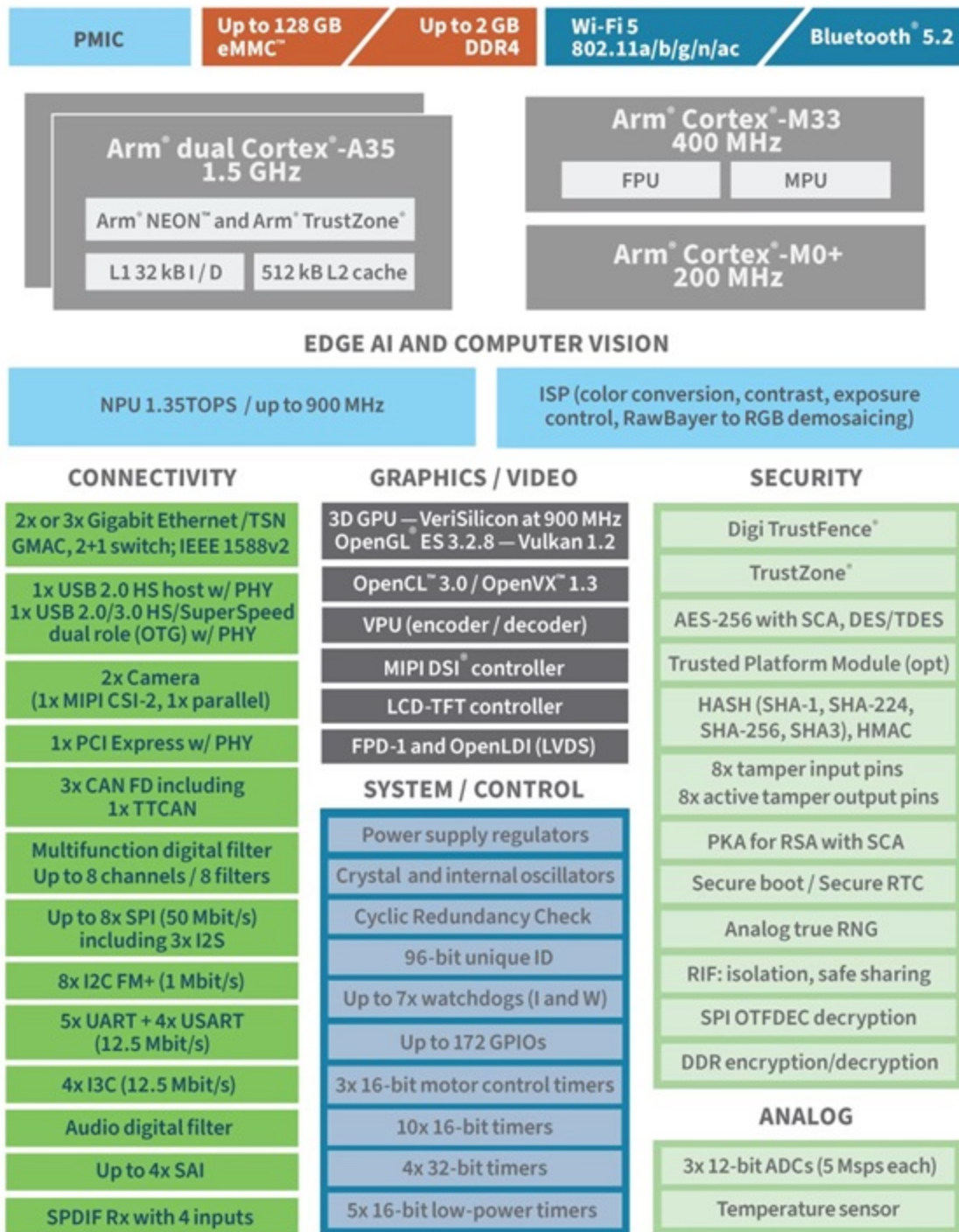
- Never drive an I/O pin beyond its positive rail or below ground.
- Never drive an I/O pin from an external power source during the power-on or reset sequences.
- Never hot-swap the module or interrupt its ground connection to external circuitry.

When you use an external supply on the carrier board supporting the ConnectCore MP25 module, make sure this supply is NOT back driving STM32MP2 I/Os while their power rails are not enabled. For example, this can happen when an external 3.3V supply is available on the carrier board and this supply powers components driven by STM32MP2 I/Os. In this case, Digi recommends you enable the external power supply after internal 3.3V is enabled, or add the necessary protection circuitry to avoid back voltage (leakage).

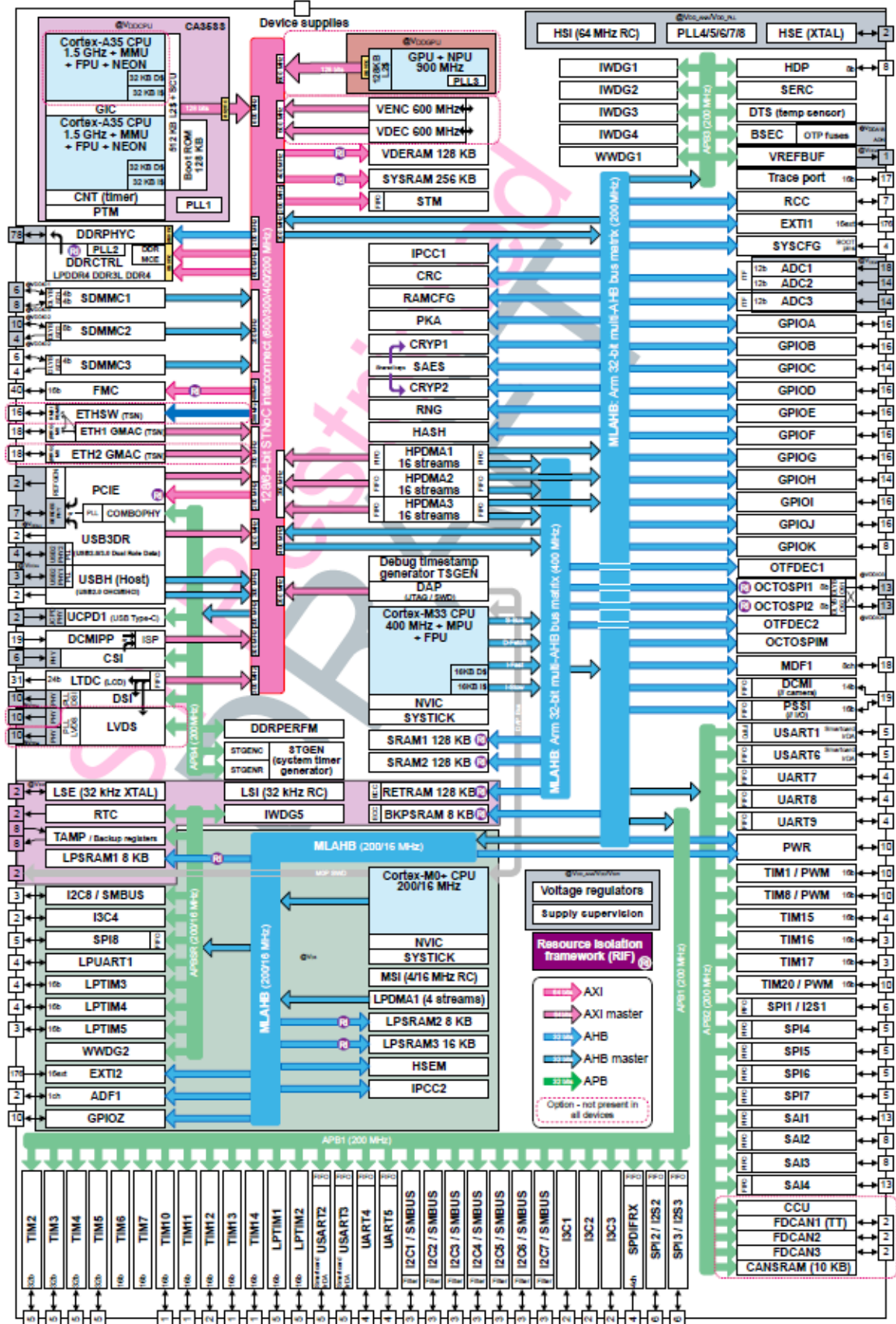
Block diagrams

The figures below show block diagrams of the ConnectCore MP25 module and of the STMicroelectronics STM32MP2 application processor.

ConnectCore MP25 module



STMicroelectronics STM32MP2 application processor



Power interfaces

System-on-module power architecture

The ConnectCore MP25 requires two primary power supply inputs: VSYS and VSYS2, which are the input power supplies to the on-module ST STPMIC25A power management IC (PMIC) that generates all required supply voltages for the module as well as the external interfaces.

The following table summarizes the PMIC regulators and switches on the ConnectCore MP25 SOM:

PMIC regulator	SOM power rail name	Input power supply	Internally used	Externally available
BUCK1	-	VSYS2	YES	NO
BUCK2	-	VSYS2	YES	NO
BUCK3	-	VSYS2	YES	NO
BUCK4	VDDIO	VSYS	YES	YES
BUCK5	1V8	VSYS2	YES	YES
BUCK6	-	VSYS2	YES	NO
BUCK7	3V3	VSYS	YES	YES
LDO1	-	VSYS	YES	NO
LDO2	-	VSYS	YES	NO
LDO3	-	-	YES	NO
LDO4	-	VSYS	YES	NO
LDO5	-	VSYS	YES	NO
LDO6	LDO6	VSYS	NO	YES
LDO7	LDO7	VSYS	NO	YES
LDO8	LDO8	VSYS	YES	YES

In addition to the input power supplies of the PMIC, there are two additional power domains of the SOM that can be set externally.

- VCC_LICELL (VBAT pad of the MCU), which powers the low power V_{SW} domain of the CPU that supplies:
 - RTC
 - TAMP
 - LSI
 - LSE
 - IWDG5
 - Backup registers

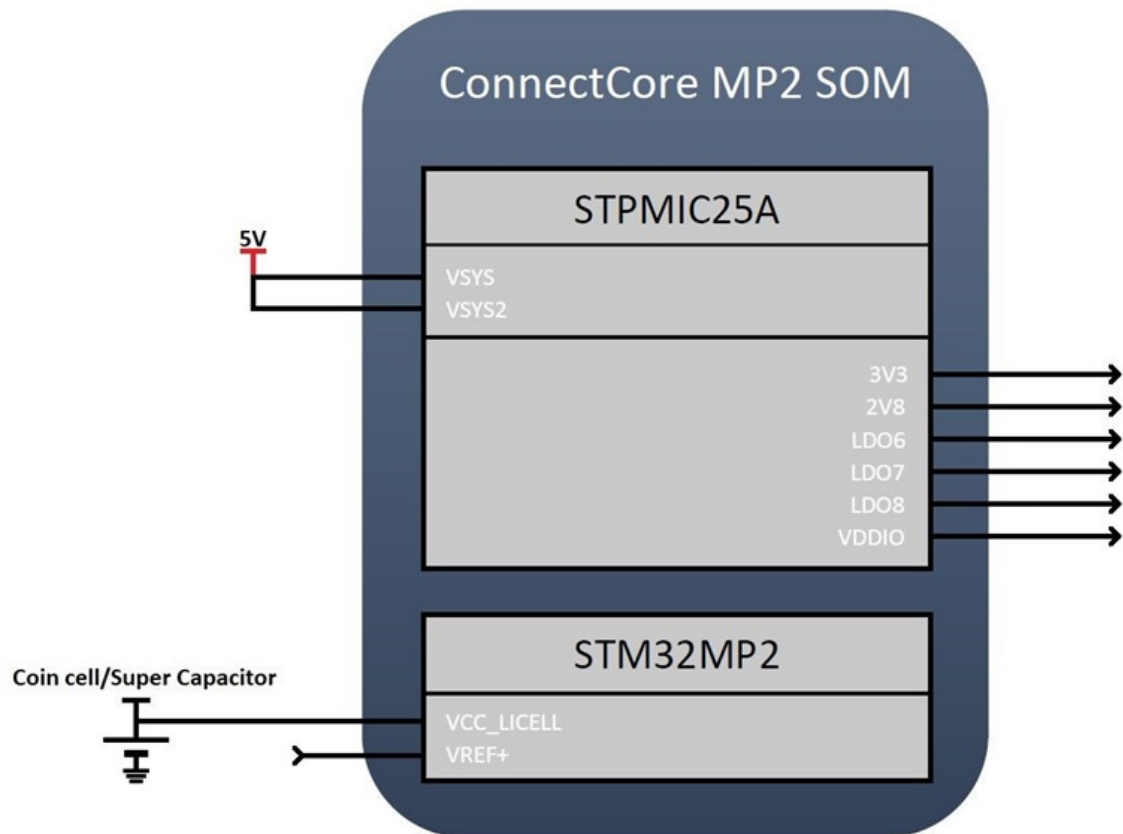
- LPSRAM1
- Retention RAM
- Backup SRAM

V_{SW} is supplied from VCC_LICELL only when there is no other supply on the system (low-power applications). Voltage on VCC_LICELL can be provided externally by a coin-cell/supercap. If low-power application is not required, then VBAT must be tied to VDDIO.

- VREF+, which is an external voltage reference for the ADC when the internal reference buffer is disabled. This supply can also be used as an output voltage reference for external components when using the internal voltage buffer.

Reference power diagram

The following diagram represents the power architecture of the ConnectCore MP25 module in a typical application:



Electrical characteristics

Input power rails

The following table lists the electrical specifications of all input power rails for the ConnectCore MP25:

Device	SOM power rail	Input voltage (V)		
		Minimum	Typical	Maximum
PMIC	VSYS	3.7	-	5.5
	VSYS2	2.8	-	5.5
CPU	VCC_LICELL	2.3	-	3.6
	VREF+	1.1	-	1.8

Output power rails

The following table lists the electrical specifications of all output power rails for the ConnectCore MP25:

SOM power rail	Used internally in the SOM	Output voltage			Accuracy (%)		Continuous output current (mA) ¹	Turn-on time (us)		Turn-off time (ms)
		Min	Typ	Max	Min	Max		Typ	Max	Max
3V3	YES	-	3.3	-	-4	4	2500	235	400	1.5
1V8	YES	-	1.8	-	-4	4	500	235	400	1.5
LDO6	NO	0.9	-	4.0	-2	2	400	160	-	1.5
LDO7	NO	0.9	-	4.0	-2	2	400	160	-	1.5
LDO8	YES	-	1.8	-	-2	2	150	160	-	1.5
VDDIO	YES	-	3.3	-	-4	4	500	235	400	1.5

Note Some of the electrical characteristics may depend on the configuration and operation mode of the different regulators. For a complete description of the electrical characteristics of the different output power rails (PMIC regulators), see the STM32MP2 datasheet.

¹ The maximum output current involves both external and internal circuitry. For those regulators that are used internally in the SOM, the current available outside will be lower.

Bootstrap

The ConnectCore MP25 system-on-module can be configured to boot from different devices and interfaces as determined by the boot ROM. The configuration of the booting process of the CPU is done through the BOOT pin and OTP bytes.

BOOT3	BOOT2	BOOT1	BOOT0	A35 master	M33 master
0	0	0	0	UART/USB	UART/USB
0	0	0	1	SD-Card	-
0	0	1	0	eMMC	-
0	0	1	1	Development	Development
0	1	0	0	S-NOR	-
0	1	1	1	-	SD-Card
1	0	0	0	-	eMMC
1	0	1	1	-	S-NOR
1	1	0	0	Development	Development
1	1	1	1	UART/USB	UART/USB

Note If the configured boot device is not valid, the system falls back to USB downloader.



CAUTION! Digi highly recommends you include a recover mechanism on every design using the ConnectCore MP25 module.

To boot from a UART port, it is mandatory to access one of the UARTs defined by ST for this purpose on the specific pads:

Signal	Pin			
	USART2	USART6	UART8	UART9
Rx	PA8	PF4	PF3	PB14
Tx	PA4	PF5	PG3	PD13

For further information, refer to STMicroelectronics documentation.

Wireless interfaces

The ConnectCore MP25 System-on-Module combines a wireless local area network (WLAN) and Bluetooth dual solution to support IEEE802.11 a/b/g/n/ac/ax WLAN standards and Bluetooth 5.4, enabling seamless integration of WLAN/Bluetooth and Low Energy technology. Digi also offers a non-wireless variant of the ConnectCore MP25 module.

The following sections include specifications for the wireless interfaces available on the ConnectCore MP25 module.

WLAN IEEE 802.11a/b/g/n/ac/ax

The following sections specify the performance of the WLAN IEEE 802.11a/b/g/n/ac/ax interface on the ConnectCore MP25 module.

Modulation and data rates

The following tables list modulation values for the ConnectCore MP25 module, which supports the following WLAN standards:

Mode	Modulation & coding	Rate
802.11b	DBPSK	1 Mbps
	DQPSK	2 Mbps
	CCK	5.5 Mbps
	CCK	11 Mbps

Mode	Modulation & coding	Rate
802.11g	BPSK-1/2	6 Mbps
	BPSK-3/4	9 Mbps
	QPSK-1/2	12 Mbps
	QPSK-3/4	18 Mbps
	16QAM-1/2	24 Mbps
	16QAM-3/4	36 Mbps
	64QAM-2/3	48 Mbps
	64QAM-3/4	54 Mbps
802.11n	BPSK-1/2	MCS0
	QPSK-1/2	MCS1
	QPSK-3/4	MCS2
	16QAM-1/2	MCS3
	16QAM-3/4	MCS4
	64QAM-2/3	MCS5
	64QAM-3/4	MCS6
	64QAM-5/6	MCS7

Mode	Modulation & coding	Rate
802.11ac	BPSK-1/2	MCS0
	QPSK-1/2	MCS1
	QPSK-3/4	MCS2
	16QAM-1/2	MCS3
	16QAM-3/4	MCS4
	64QAM-2/3	MCS5
	64QAM-3/4	MCS6
	64QAM-5/6	MCS7
	256QAM-3/4	MCS8
	256QAM-5/6	MCS9
802.11ax	BPSK-1/2	MCS0
	QPSK-1/2	MCS1
	QPSK-3/4	MCS2
	16QAM-1/2	MCS3
	16QAM-3/4	MCS4
	64QAM-2/3	MCS5
	64QAM-3/4	MCS6
	64QAM-5/6	MCS7
	256QAM-3/4	MCS8
	256QAM-5/6	MCS9
	1024QAM-3/4	MCS10
	1024QAM-5/6	MCS11

Data rate (Mbps) - Non Short Guard Interval (Non-SGI)

Data rate (Mbps)		802.11b		802.11ga		802.11n		802.11ac			802.11ax		
		DBPSK	CCK	BPSK-1/2	64QAM-3/4	BPSK-1/2	64QAM-5/6	BPSK-1/2	64QAM-5/6	256QAM-5/6	BPSK-1/2	64QAM-5/6	1024QAM-5/6
Modulation		1 Mbps	11 Mbps	6 Mbps	54 Mbps	MCS0	MCS7	MCS0	MCS7	MCS9	MCS0	MCS7	MCS11
2.4 GHz	HT20	1	11	6	54	6.5	65	6.5	65		4	81	135
	HT40					13.5	135	13.5	135	180	8	163	271
5 GHz	HT20			6	54	6.5	65	6.5	65		4	81	135
	HT40					13.5	135	13.5	135	180	8	163	271
	HT80							29.3	292.5	390	17	340	600

Data rate (Mbps) - Short Guard Interval (SGI)

Data rate (Mbps)		802.11b		802.11ga		802.11n		802.11ac			802.11ax		
		DBPSK	CCK	BPSK-1/2	64QAM-3/4	BPSK-1/2	64QAM-5/6	BPSK-1/2	64QAM-5/6	256QAM-5/6	BPSK-1/2	64QAM-5/6	1024QAM-5/6
Modulation		1 Mbps	11 Mbps	6 Mbps	54 Mbps	MCS0	MCS7	MCS0	MCS7	MCS9	MCS0	MCS7	MCS11
2.4 GHz	HT20	1	11	6	54	7.2	72.2	7.2	72.2		8.6	86	143
	HT40					15	150	15	150	200	17.2	172	287

Data rate (Mbps)		802.11b		802.11ga		802.11n		802.11ac			802.11ax		
		DBPSK	CCK	BPSK-1/2	64QAM-3/4	BPSK-1/2	64QAM-5/6	BPSK-1/2	64QAM-5/6	256QAM-5/6	BPSK-1/2	64QAM-5/6	1024QAM-5/6
Modulation		1 Mbps	11 Mbps	6 Mbps	54 Mbps	MCS0	MCS7	MCS0	MCS7	MCS9	MCS0	MCS7	MCS11
5 GHz	HT20			6	54	7.2	72.2	7.2	72.2		8.6	86	143
	HT40					15	150	15	150	200	17.2	172	287
	HT80							32.5	325	433.3	36	360	600

RF channels

The ConnectCore MP25 module supports the following frequency bands:

RF band	Ch. BW	Ch. spacing	Channel number (Center freq. MHz)
2.4 GHz	20 MHz	5 MHz	1(2412), 2(2417), 3(2422), 4(2427), 5(2432), 6(2437), 7(2442), 8(2447), 9(2452), 10(2457), 11(2462), 12(2467), 13(2472), 14(2484)
	40 MHz	5 MHz	3(2422), 11(2462)
5 GHz	20 MHz	20 MHz	36(5180), 40(5200), 44(5220), 48(5240), 52(5260), 56(5280), 60(5300), 64(5320), 100(5500), 104(5520), 108(5540), 112(5560), 116(5580), 120(5600), 124(5620), 128(5640), 132(5660), 136(5680), 140(5700), 144(5720), 149(5745), 153(5765), 157(5785), 161(5805), 165(5825)
	40 MHz	40 MHz	38(5190), 46(5230), 54(5270), 62(5310), 102(5510), 110(5550), 118(5590), 126(5630), 134(5670), 142(5710), 151(5755), 159(5795)
	80 MHz	80 MHz	42(5210), 58(5290), 106(5530), 122(5610), 138(5690), 155(5775)

Note Dependent upon regulatory bodies.

2.4 GHz

2.4 GHz band channel #	Center frequency (MHz)	EUROPE (ETSI)	NORTH AMERICA (FCC)	JAPAN
1	2412	✓	✓	✓
2	2417	✓	✓	✓
3	2422	✓	✓	✓
4	2427	✓	✓	✓
5	2432	✓	✓	✓
6	2437	✓	✓	✓
7	2442	✓	✓	✓
8	2447	✓	✓	✓
9	2452	✓	✓	✓
10	2457	✓	✓	✓
11	2462	✓	✓	✓
12	2467	✓	No	✓
13	2472	✓	No	✓
14	2484	No	No	802.11b only

5 GHz

5 GHz band channel #	Center frequency (MHz)	EUROPE (ETSI)	NORTH AMERICA (FCC)	JAPAN
36	5180	Indoors	✓	✓
40	5200	Indoors	✓	✓
44	5220	Indoors	✓	✓
48	5240	Indoors	✓	✓
52	5260	Indoors / DFS / TPC	DFS	DFS / TPC
56	5280	Indoors / DFS / TPC	DFS	DFS / TPC
60	5300	Indoors / DFS / TPC	DFS	DFS / TPC
64	5320	Indoors / DFS / TPC	DFS	DFS / TPC
100	5500	DFS / TPC	DFS	DFS / TPC
104	5520	DFS / TPC	DFS	DFS / TPC
108	5540	DFS / TPC	DFS	DFS / TPC
112	5560	DFS / TPC	DFS	DFS / TPC
116	5580	DFS / TPC	DFS	DFS / TPC
120	5600	DFS / TPC	DFS	DFS / TPC
124	5620	DFS / TPC	DFS	DFS / TPC
128	5640	DFS / TPC	DFS	DFS / TPC
132	5660	DFS / TPC	DFS	DFS / TPC
136	5680	DFS / TPC	DFS	DFS / TPC

5 GHz band channel #	Center frequency (MHz)	EUROPE (ETSI)	NORTH AMERICA (FCC)	JAPAN
140	5700	DFS / TPC	DFS	DFS / TPC
149	5745	SRD	✓	No Access
153	5765	SRD	✓	No Access
157	5785	SRD	✓	No Access
161	5805	SRD	✓	No Access
165	5825	SRD	✓	No Access

Note

DFS = Dynamic Frequency Selection

TPC = Transmit Power Control

SRD = Short Range Devices 25 mW max power

Transmit power

The following table lists nominal transmit power values for the ConnectCore MP25 module based on Murata LBEE5HY2GY-SMP specification.

RF band (GHz)	Standard	Output power (dBm)
2.4	802.11b	18 (1 Mbps) - 18 (11 Mbps)
	802.11g	17 (6 Mbps) - 17 (54 Mbps)
	802.11n	16 (MCS0) - 16 (MCS7)
	802.11ax	12 (MCS0) - 12 (MCS11)
5	802.11a	16 (6Mbps) - 16 (54 Mbps)
	802.11n (HT20)	14 (MCS0) - 14 (MCS7)
	802.11ac (VHT20)	12 (MCS0) - 12 (MCS8)
	802.11ax (HE20)	9 (MCS0) - 9 (MCS11)

Note Output power values are subject to change.

Antenna ports

The ConnectCore MP25 module has one antenna port on the module via a dedicated U.FL connector. The antenna port supports WLAN and Bluetooth functionality.

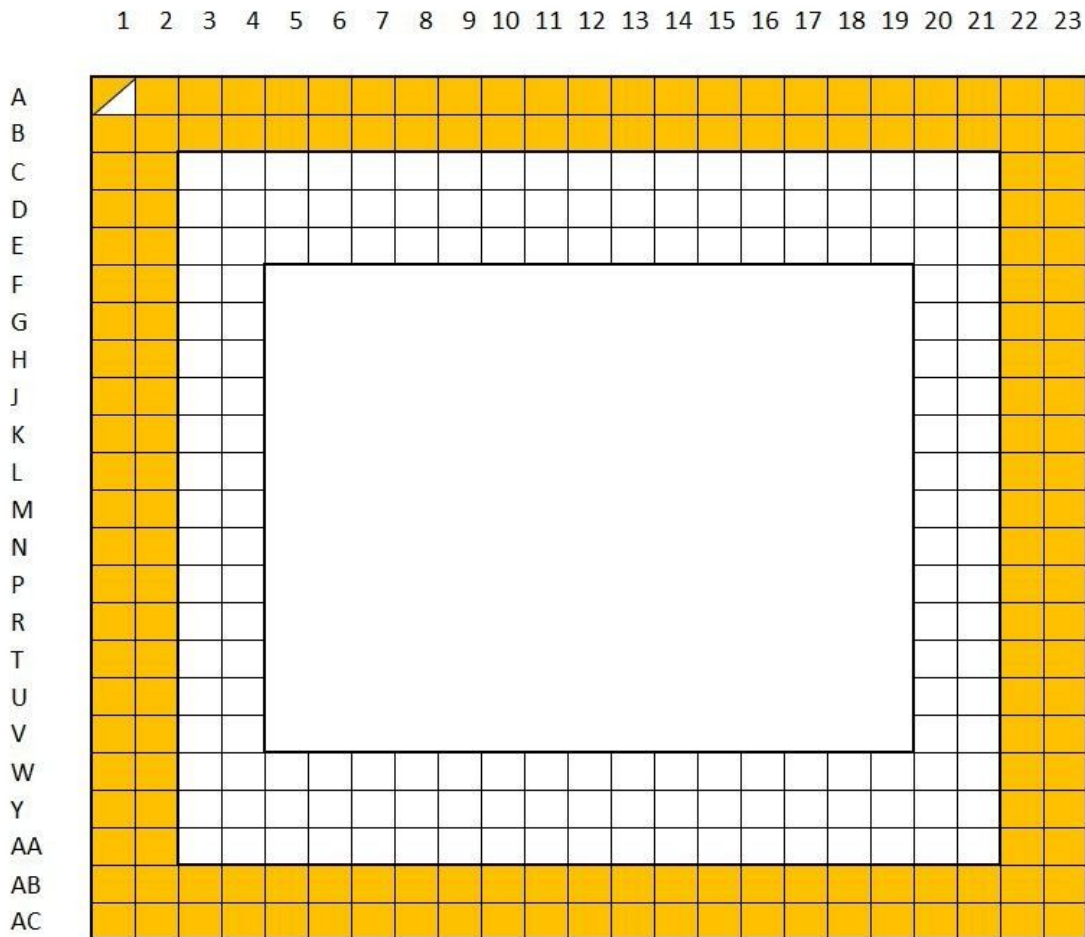
Bluetooth

The ConnectCore MP25 module supports both Bluetooth and Bluetooth Low Energy protocols:

- Bluetooth 5.4
- Integrated WLAN-Bluetooth coexistence

Module pinout

The ConnectCore MP25 module provides LGA 334 pins. The general layout can be found on the following diagram (view from top side):



Note Orange cells represent external ring pads, a group of pads that supports a subset of the SOM functionality. You can use these external pads to meet limited-functionality design requirements, simplifying the assembly process of the module.

External signals and pin multiplexing

The following tables provide the pinout information of the ConnectCore MP25 module. For additional information related to the signals listed in the table, refer to the STMicroelectronics STM32MP2 technical documentation.

Note See [Limitations and notices](#) for important information on designing your hardware.

Digi ConnectCore Smart IOMUX tool

The Digi ConnectCore Smart IOMUX tool can dramatically simplify pin configuration and resolution. You can enter the list of interfaces required by your project and use the Smart IOMUX graphical interface to mock up configuration options, resulting in full pin assignment and device tree snippets that match your desired functionality. See the [Smart IOMUX User Guide](#) for more information and download instructions.

Pad signals and multiplexing

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
A1	GND				
A2	RF_ANT_EXT				
A3	GND				
A4	LVDS1_D0_N	LVDS1_D0N			
A5	LVDS1_D0_P	LVDS1_D0P			
A6	GND				
A7	LVDS1_D1_N	LVDS1_D1N			
A8	LVDS1_D1_P	LVDS1_D1P			
A9	GND				
A10	LVDS1_D2_N	LVDS1_D2N			
A11	LVDS1_D2_P	LVDS1_D2P			
A12	USART2_TX	PA4	AF6: USART2_TX AF7: FDCAN2_TX AF8: TIM2_CH1 AF10: LCD_R1 AF13: ETH1_PTP_AUX_TS AF14: ETH3_PPS_OUT AF15: EVENTOUT		VDDIO
A13	USART2_RX	PA8	AF1: LPTIM2_CH2 AF2: SPI7_NSS AF4: SAI1_FS_B AF6: USART1_CK		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF8: USART2_RX AF9: I2C5_SCL AF12: LCD_B2 AF13: DCMI_D4/PSSI_D4/DCMIPP_D4 AF15: EVENTOUT		
A14	I2C1_SCL	PG13	AF0: TRACED11 AF1: HDP3 AF2: SPI7_SCK AF5: MDF1_CK16 AF8: TIM8_CH2N AF9: I2C1_SCL AF10: I3C1_SCL AF13: LCD_G7 AF14: DCMI_D7/PSSI_D7/DCMIPP_D7 AF15: EVENTOUT		VDDIO
A15	DSI_D0_N	DSI_D0N			
A16	DSI_D0_P	DSI_D0P			
A17	GND				
A18	DSI_D1_N	DSI_D1N			
A19	DSI_D1_P	DSI_D1P			
A20	GND				
A21	DSI_CK_N	DSI_CKN			
A22	DSI_CK_P	DSI_CKP			
A23	GND				
B1	ETH1_TXD3	PH11	AF3: SPI6_MISO AF4: SAI3_FS_A AF7: TIM15_CH2		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF9: ETH2_MDIO AF10: ETH1_MII_TXD3/ETH1_RGMII_TXD3 AF15: EVENTOUT		
B2	GND				
B3	3V3				
B4	GND				
B5	LVDS1_CLK_N	LVDS1_D4N			
B6	LVDS1_CLK_P	LVDS1_D4P			
B7	GND				
B8	LVDS1_D3_N	LVDS1_D3N			
B9	LVDS1_D3_P	LVDS1_D3P			
B10	PB0	PB0	AF2: SPI2_SCK/I2S2_CK AF6: USART1_CK AF7: TIM16_CH1 AF8: TIM20_CH4N AF10: OCTOSPIM_P2_IO0 AF15: EVENTOUT		VDDIO
B11	GND				
B12	PB6	PB6	AF2: SPI2_MISO/I2S2_SDI AF3: UART4_RX AF4: SAI4_SCK_B AF8: TIM20_CH1N AF10: OCTOSPIM_P2_IO6 AF12: FMC_AD9/FMC_D9 AF14: SDMMC3_D0DIR AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
B13	1V8				
B14	I2C1_SDA	PI1	AF0: TRACED15 AF1: HDP7 AF2: SPI7_NSS AF5: MDF1_SDI6 AF8: TIM8_CH3N AF9: I2C1_SDA AF10: I3C1_SDA AF13: LCD_B4 AF14: DCM1_D8/PSSI_D8/DCMIPP_D8 AF15: EVENTOUT		VDDIO
B15	GND				
B16	DSI_D2_N	DSI_D2N			
B17	DSI_D2_P	DSI_D2P			
B18	GND				
B19	DSI_D3_N	DSI_D3N			
B20	DSI_D3_P	DSI_D3P			
B21	PB3	PB3	AF2: SPI2_NSS/I2S2_WS AF5: MDF1_SDI3 AF8: TIM20_CH3 AF10: OCTOSPIM_P2_IO3 AF12: FMC_NCE3 AF15: EVENTOUT		VDDIO
B22	PF12	PF12	AF0: TRACECLK AF2: SPI5_MISO AF3: SPI1_MISO/I2S1_SDI AF6: UART9_RTS/UART9_DE AF8: TIM5_CH1 AF13: LCD_CLK		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF14: DCMI_D0/PSSI_D0/DCMIPP_D0 AF15: EVENTOUT		
B23	USB1_D_P	USB3DR_DP			
C1	ETH1_TXD2	PH10	AF2: SPI1_SCK/I2S1_CK AF3: SPI6_MOSI AF4: SAI3_SCK_A AF7: TIM15_CH1 AF9: ETH2_MDC AF10: ETH1_MII_TXD2/ETH1_RGMII_TXD2 AF15: EVENTOUT	ADC3_INP8 ADC3_INN4	VDDIO
C2	ETH1_GTX_CLK	PC0	AF1: LPTIM1_CH1 AF3: SPI6_SCK AF4: SAI3_MCLK_B AF5: USART6_TX AF9: DCMI_D0/PSSI_D0/DCMIPP_D0 AF10: ETH2_MII_RX_CLK/ETH2_RGMII_RX_CLK/ETH2_RMII_REF_CLK AF11: ETH1_MII_TX_CLK AF12: ETH1_RGMII_GTX_CLK AF13: LCD_G7 AF15: EVENTOUT		VDDIO
C3	PCM_OUT				
C4	WL_REG_EN/PI7	PI7	AF6: USART3_RX AF7: TIM2_CH1 AF8: TIM3_CH2 AF13: LCD_HSYNC AF15: EVENTOUT		VDDIO
C5	USART1_TX	PG14	AF0: TRACED12 AF1: HDP4 AF2: SPI7_RDY AF5: MDF1_CK15		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF6: USART1_TX AF8: TIM8_BKIN2 AF13: LCD_B1 AF14: DCM1_D9/PSSI_D9/DCMIPP_D9 AF15: EVENTOUT		
C6	USART1_RX	PG15	AF0: TRACED13 AF1: HDP5 AF3: LPTIM1_CH2 AF5: MDF1_SDI5 AF6: USART1_RX AF8: TIM8_ETR AF13: LCD_B2 AF14: DCM1_D10/PSSI_D10/DCMIPP_D10 AF15: EVENTOUT		VDDIO
C7	WLAN_SD1_CLK	PE3	AF0: TRACECLK AF2: SPI1_RDY AF3: SPI3_SCK/I2S3_CK AF4: SAI1_MCLK_B AF6: USART3_TX AF8: TIM11_CH1 AF10: SDMMC1_CK AF15: EVENTOUT		LDO8
C8	WLAN_SD1_D1	PE5	AF0: TRACED1 AF1: LPTIM2_IN2 AF2: SPI1_NSS/I2S1_WS AF3: SPI3_NSS/I2S3_WS AF4: SAI1_FS_B AF6: USART3_RTS/USART3_DE AF7: FDCAN1_RX AF10: SDMMC1_D1 AF15: EVENTOUT		LDO8
C9	WLAN_SD1_D3	PE1	AF0: TRACED3		LDO8

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF1: LPTIM2_CH2 AF2: I2S1_MCK AF3: I2S3_MCK AF6: USART3_RX AF10: SDMMC1_D3 AF15: EVENTOUT		
C10	NC				
C11	NC				
C12	NC				
C13	NC				
C14	NC				
C15	NC				
C16	NC				
C17	NC				
C18	NC				
C19	NC				
C20	NC				
C21	NC				
C22	NC				
C23	USB1_D_N	USB3DR_DM			
D1	ETH1_TXD1	PC1	AF2: SPI3_MOSI/I2S3_SDO AF6: USART2_TX AF9: I2C7_SCL AF10: ETH1_MII_TXD1/ETH1_RGMII_		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			TXD1/ETH1_RMII_TXD1 AF15: EVENTOUT		
D2	GND				
D3	PCM_CLK				
D4	BT_REG_EN/PZ5	PZ5	AF1: MCO1 AF2: LPTIM3_ETR AF3: SPI8_SCK AF5: ADF1_CCK0 AF6: LPUART1_RTS/LPUART1_DE AF7: LPTIM5_IN1 AF10: LPTIM4_CH2 AF15: EVENTOUT	TAMP_OUT8	VSW
D5	USART1_RTS	PB9	AF1: SPI3_RDY AF6: USART1_RTS/USART1_DE AF7: FDCAN1_TX AF8: TIM20_BKIN AF9: TIM10_CH1 AF10: OCTOSPIM_P2_DQS AF11: OCTOSPIM_P2_NCS2 AF12: FMC_AD13/FMC_D13 AF15: EVENTOUT		VDDIO
D6	USART1_CTS	PB11	AF1: I2S3_MCK AF6: USART1_CTS/USART1_NSS AF7: FDCAN1_RX AF8: TIM20_BKIN2 AF9: TIM12_CH2 AF10: OCTOSPIM_P2_NCLK AF11: OCTOSPIM_P2_NCS2 AF12: FMC_AD14/FMC_D14 AF13: OCTOSPIM_P1_NCS2 AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
D7	WLAN_SD1_CMD	PE2	AF1: LPTIM2_ETR AF2: SPI1_MISO/I2S1_SDI AF3: SPI3_MOSI/I2S3_SDO AF4: SAI1_SCK_B AF8: TIM10_CH1 AF10: SDMMC1_CMD AF15: EVENTOUT		LDO8
D8	WLAN_SD1_D0	PE4	AF0: TRACED0 AF1: LPTIM2_IN1 AF2: SPI1_MOSI/I2S1_SDO AF3: SPI3_MISO/I2S3_SDI AF4: SAI1_SD_B AF6: USART3_CTS/USART3_NSS AF7: FDCAN1_TX AF10: SDCMMC1_D0 AF15: EVENTOUT		LDO8
D9	WLAN_SD1_D2	PE0	AF0: TRACED2 AF1: LPTIM2_CH1 AF2: SPI1_SCK/I2S1_CK AF3: SPI3_RDY AF6: USART3_CK AF10: SDMMC1_D2 AF15: EVENTOUT		LDO8
D10	WL_DEV_WAKE				
D11	NC				
D12	NC				
D13	NC				
D14	NC				
D15	NC				

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
D16	NC				
D17	NC				
D18	NC				
D19	NC				
D20	VDDIO				
D21	LDO6				
D22	NC				
D23	GND				
E1	ETH1_TXD0	PA15	AF2: SPI3_MISO/I2S3_SDI AF6: USART2_RX AF9: I2C7_SDA AF10: ETH1_MII_TXD0/ETH1_RGMII_TXD0/ETH1_RMII_TXD0 AF15: EVENTOUT		VDDIO
E2	ETH1_TX_CTL/EN	PA13	AF1: SPI8_RDY AF2: I2S3_MCK AF3: LPTIM2_ETR AF5: MDF1_CK13 AF6: USART2_CTS/USART2_NSS AF9: I2C7_SMBA AF10: ETH1_MII_TX_EN/ETH1_RGMII_TX_CTL/ETH1_RMII_TX_EN AF15: EVENTOUT		VDDIO
E3	PCM_SYNC				
E4	PCM_IN				
E5	WL_HOST_WAKE				

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
E6	BT_HOST_WAKE				
E7	BT_DEV_WAKE				
E8	GND				
E9	PCIE_CLKIN_N	PCIE_CLKINN			
E10	PCIE_CLKIN_P	PCIE_CLKINP			
E11	GND				
E12	PCIE_CLKOUT_N	PCIE_CLKOUTN			
E13	PCIE_CLKOUT_P	PCIE_CLKOUTP			
E14	GND				
E15	PCIE_TX1_N	COMBOPHY_TX1N			
E16	PCIE_TX1_P	COMBOPHY_TX1P			
E17	GND				
E18	PCIE_RX1_N	COMBOPHY_RX1N			
E19	PCIE_RX1_P	COMBOPHY_RX1P			
E20	GND				
E21	RESERVED				
E22	NC				
E23	NC				
F1	GND				
F2	ETH1_RX_CTL/DV	PA11	AF1: SPI8_SCK AF2: LPTIM2_CH1		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF4: SAI4_SD_B AF5: MDF1_SD14 AF10: ETH1_MII_RX_DV/ETH1_RGMII_RX_CTL/ETH1_RMII_CRS_DV AF15: EVENTOUT		
F3	3V3				
F4	PH2	PH2	AF1: LPTIM2_CH1 AF2: SPI7_RDY AF3: SPDIFRX1_IN3 AF4: SAI1_SCK_B AF5: I3C3_SDA AF7: TIM16_CH1 AF8: I2C5_SDA AF9: I2C3_SDA AF14: ETH3_RGMII_GTX_CLK AF15: EVENTOUT		VDDIO
F20	TPM_SPI_CLK				
F21	NRSTC1MS				
F22	VCC_LICELL				
F23	NRST				
G1	ETH1_RXD0	PF1	AF1: SPI8_MISO AF2: LPTIM2_IN2 AF4: SAI4_SCK_B AF5: MDF1_CK14 AF6: USART2_CK AF10: ETH1_MII_RXD0/ETH1_RGMII_RXD0/ETH1_RMII_RXD0 AF15: EVENTOUT		VDDIO
G2	ETH1_RX_CLK	PA14	AF1: SPI8_NSS		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF2: LPTIM2_CH2 AF4: SAI4_FS_B AF5: MDF1_CCK1 AF10: ETH1_MII_RX_CLK/ETH1_RGMII_RX_CLK/ETH1_RMII_REF_CLK AF15: EVENTOUT		
G3	PB15	PB15	AF1: LPTIM1_IN2 AF2: SPI5_SCK AF3: UART8_RTS/UART8_DE AF4: SAI2_SD_B AF5: UART5_RX AF7: TIM3_CH2 AF8: TIM5_CH1 AF10: ETH1_PPS_OUT AF12: FMC_A18 AF13: LCD_R4 AF14: DCMI_D8/PSSI_D8/DCMIPP_D8 AF15: EVENTOUT	ADC1_INP15 ADC3_INP5	VDDIO
G4	GND				
G20	TPM_SPI_MISO				
G21	TPM_SPI_MOSI				
G22	BOOT0	BOOT0			
G23	BOOT1	BOOT1			
H1	ETH1_RXD1	PC2	AF1: SPI8_MOSI AF2: LPTIM2_IN1 AF4: SAI4_MCLK_B AF5: MDF1_SDI3 AF6: USART2_RTS/USART2_DE AF10: ETH1_MII_RXD1/ETH1_RGMII_RXD1/ETH1_RMII_RXD1		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF15: EVENTOUT		
H2	ETH1_CLK125	PH9	AF3: SPI6_NSS AF4: SAI3_MCLK_A AF6: USART6_RX AF7: TIM15_CH1N AF10: ETH1_RGMII_CLK125 AF11: ETH1_MII_RX_ER AF15: EVENTOUT	ADC3_INP4	VDDIO
H3	GND				
H4	PA3	PA3	AF1: LPTIM2_ETR AF2: SPI7_MOSI AF5: MDF1_CK17 AF6: USART1_TX AF8: I3C1_SCL AF9: I2C7_SMBA AF10: I2C1_SCL AF11: LCD_B1 AF13: DCM1_D2/PSSI_D2/DCMIPP_D2 AF14: ETH3_RGMII_TX_CTL/ETH3_RMII_TX_EN AF15: EVENTOUT		VDDIO
H20	TPM_SPI_I2C				
H21	TPM_SPI_CS				
H22	BOOT2	BOOT2			
H23	BOOT3	BOOT3			
J1	ETH1_RXD2	PH12	AF2: SPI3_NSS/I2S3_WS AF3: SPI6_MISO AF8: TIM10_CH1 AF10: ETH1_MII_RXD2/ETH1_RGMII_		VDDIO

Pad	ConnectCore MP25 sigal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			RXD2 AF15: EVENTOUT		
J2	PA12	PA12	AF2: SPI6_MOSI AF4: SAI3_FS_A AF7: TIM4_CH1 AF8: I2C4_SCL AF9: I2C6_SCL AF10: ETH1_PHY_INTN AF15: EVENTOUT		VDDIO
J3	PA6	PA6	AF3: SPI4_SCK AF4: SAI2_FS_B AF5: MDF1_SDI6 AF6: USART2_CK AF7: TIM13_CH1 AF8: TIM2_ETR AF10: LCD_G4 AF12: FMC_NE1 AF13: DCM1_D12/PSSI_D12/DCMIPP_D12 AF14: ETH3_RGMII_TXD0/ETH3_RMII_TXD0 AF15: EVENTOUT		VDDIO
J4	PA2	PA2	AF1: LPTIM2_IN1 AF2: SPI7_MISO AF5: MDF1_SDI7 AF6: USART1_RX AF8: I3C1_SDA AF10: I2C1_SDA AF11: LCD_B0 AF13: DCM1_D3/PSSI_D3/DCMIPP_D3 AF14: ETH3_RGMII_RX_CTL/ETH3_RMII_CRS_DV AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
J20	GND				
J21	GND				
J22	PMIC_PONKEY_N				
J23	PWR_ON	PWR_ON			
K1	ETH1_RXD3	PH13	AF2: SPI3_SCK/I2S3_CK AF3: SPI6_MOSI AF7: TIM15_BKIN AF8: TIM11_CH1 AF10: ETH1_MII_RXD3/ETH1_RGMII_RXD3 AF15: EVENTOUT		VDDIO
K2	ETH1_MDIO	PF2	AF2: SPI3_RDY AF6: I2C4_SMBA AF8: TIM12_CH1 AF9: I2C2_SCL AF10: ETH1_MDIO AF11: ETH2_MII_COL AF12: FMC_NE4 AF13: I3C2_SCL AF15: EVENTOUT	ADC1_INP13 ADC1_INN11 ADC2_INP13 ADC2_INN11 ADC3_INP13 ADC3_INN11	VDDIO
K3	PA7	PA7	AF2: AUDIOCLK AF3: SPI6_RDY AF4: PCIE_CLKREQN AF5: MDF1_CCK0 AF6: USART1_CTS/USART1_NSS AF7: TIM4_ETR AF8: I2C2_SMBA AF9: I2C6_SMBA AF10: LCD_B5 AF11: I2C3_SMBA AF12: I2C4_SMBA		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF13: DCMI_D6/PSSI_D6/DCMIPP_D6 AF14: ETH3_RGMII_TXD1/ETH3_RMII_TXD1 AF15: EVENTOUT		
K4	GND				
K20	VSYS				
K21	VSYS				
K22	VSYS				
K23	VSYS				
L1	GND				
L2	ETH1_MDC	PF0	AF2: SPI3_SCK/I2S3_CK AF7: FDCAN2_RX AF8: TIM12_CH2 AF9: I2C2_SDA AF10: ETH1_MDC AF11: ETH2_MII_CRS AF13: I3C2_SDA AF15: EVENTOUT	ADC1_INP11 ADC2_INP11 ADC3_INP11	VDDIO
L3	PH6	PH6	AF1: LPTIM2_IN2 AF4: SAI1_MCLK_B AF5: I3C3_SCL AF7: TIM16_CH1N AF8: I2C5_SCL AF9: I2C3_SCL AF10: I2C1_SMBA AF14: ETH3_RGMII_TXD2 AF15: EVENTOUT		VDDIO
L4	PA5	PA5	AF3: SPI4_MOSI AF4: SAI2_MCLK_B		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF5: SAI2_SD_B AF6: USART2_RTS/USART2_DE AF7: FDCAN2_RX AF8: TIM2_CH4 AF10: LCD_G0 AF12: FMC_A0 AF13: DCMI_D13/PSSI_D13/DCMIPP_D13 AF14: ETH3_RGMII_RX_CLK/ETH3_RMII_REF_CLK AF15: EVENTOUT		
L20	VSYS2				
L21	VSYS2				
L22	VSYS2				
L23	VSYS2				
M1	ETH1_CLK	PF3	AF3: UART8_RX AF4: SAI2_SCK_B AF5: MDF1_CCK0 AF7: TIM3_CH4 AF8: TIM8_BKIN2 AF9: ETH1_CLK AF10: ETH2_PPS_OUT AF12: FMC_A20 AF13: LCD_R6 AF14: DCMI_HSYNC/PSSI_DE/DCMIPP_HSYNC AF15: EVENTOUT	ADC1_INP16 ADC1_INN15	VDDIO
M2	ETH1_RST	PB2	AF2: SPI2_MOSI/I2S2_SDO AF5: MDF1_CK13 AF6: TIM17_BKIN AF7: TIM16_BKIN AF8: TIM20_CH2N		VDDIO

Pad	ConnectCore MP25 sigal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF10: OCTOSPIM_P2_IO2 AF15: EVENTOUT		
M3	PH3	PH3	AF2: SPI1_NSS/I2S1_WS AF6: UART7_RX AF7: TIM17_CH1N AF9: TIM5_CH3 AF10: I2C7_SCL AF14: ETH3_RGMII_TXD3 AF15: EVENTOUT		VDDIO
M4	NC				
M20	NC				
M21	3V3				
M22	3V3				
M23	GND				
N1	3V3				
N2	NC				
N3	PA9	PA9	AF3: SPI4_NSS AF4: SAI2_SCK_B AF6: USART2_CTS/USART2_NSS AF7: LPTIM5_ETR AF8: TIM2_CH3 AF10: ETH1_MDC AF12: LCD_G7 AF13: PSSI_D14/DCMIPP_D14 AF14: ETH3_RGMII_RXD0/ETH3_RMII_RXD0 AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
N4	GND				
N20	NC				
N21	1V8				
N22	1V8				
N23	USB2_D_P	USBH_HS_DP			
P1	NC				
P2	GND				
P3	PA10	PA10	AF3: SPI4_MISO AF4: SAI2_SD_B AF6: USART2_RX AF7: LPTIM5_IN1 AF8: TIM2_CH2 AF10: ETH1_MDIO AF12: LCD_R6 AF13: PSSI_D15/DCMIPP_D15 AF14: ETH3_RGMII_RXD1/ETH3_RMII_RXD1 AF15: EVENTOUT		VDDIO
P4	NC				
P20	GND				
P21	NC				
P22	GND				
P23	USB2_D_N	USBH_HS_DM			
R1	NC				
R2	SAI4_MCLK_B	PI0	AF0: TRACED14		VDDIO

Pad	ConnectCore MP25 sigal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF1: HDP6 AF3: LPTIM1_IN1 AF4: SAI4_MCLK_B AF6: USART1_CK AF8: TIM8_BKIN AF13: LCD_B3 AF14: DCM1_D11/PSSI_D11/DCMIPP_D11 AF15: EVENTOUT		
R3	PH7	PH7	AF2: SPI1_MOSI/I2S1_SDO AF4: UART4_TX AF6: UART7_RTS/UART7_DE AF7: TIM17_CH1 AF9: TIM5_CH4 AF10: I2C7_SDA AF14: ETH3_RGMII_RXD2 AF15: EVENTOUT		VDDIO
R4	GND				
R20	NC				
R21	NC				
R22	PH5	PH5	AF4: SAI2_FS_A AF6: UART8_CTS AF7: TIM2_CH1 AF8: UART7_RX AF10: LCD_G1 AF11: USB3DR_VBUSEN AF12: USBH_HS_VBUSEN AF13: ETH2_PTP_AUX_TS AF15: EVENTOUT	WKUP2	VDDIO
R23	PH4	PH4	AF6: UART7_TX AF7: TIM17_BKIN AF9: TIM5_CH2	BOOTFAILN	VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF10: LCD_R0 AF11: USB3DR_OVRCUR AF12: USBH_HS_OVRCUR AF13: ETH1_PTP_AUX_TS AF14: ETH3_PPS_OUT AF15: EVENTOUT		
T1	GND				
T2	SAI4_SCK_B	PI2	AF3: LPTIM1_ETR AF4: SAI4_SCK_B AF6: USART1_RTS/USART1_DE AF8: TIM8_CH1 AF13: LCD_B5 AF14: DCM1_D13/PSSI_D13/DCMIPP_D13 AF15: EVENTOUT		VDDIO
T3	PH8	PH8	AF2: SPI1_MISO/I2S1_SDI AF3: SPDIFRX1_IN3 AF4: UART4_RX AF6: UART7_CTS AF9: TIM5_CH1 AF10: I2C3_SMBA AF11: I2C5_SMBA AF14: ETH3_RGMII_RXD3 AF15: EVENTOUT		VDDIO
T4	NC				
T20	NC				
T21	GND				
T22	NC				
T23	SPI3_MISO	PB10	AF1: SPI3_MISO/I2S3_SDI AF6: USART1_RX AF7: TIM17_CH1N		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF10: OCTOSPIM_P2_CLK AF12: FMC_AD15/FMC_D15 AF15: EVENTOUT		
U1	SAI4_SD_A	PD1	AF1: HDP1 AF2: SPI1_MISO/I2S1_SDI AF3: SAI1_CK2 AF5: SAI4_SD_A AF6: UART7_RTS/UART7_DE AF7: TIM15_CH1 AF8: TIM1_BKIN AF9: FDCAN3_RX AF10: OCTOSPIM_P1_NCLK AF11: OCTOSPIM_P1_NCS2 AF12: OCTOSPIM_P2_NCS2 AF13: DCM1_HSYNC/PSSI_DE/DCMIPP_HSYNC AF15: EVENTOUT		VDDIO
U2	SAI4_SD_B	PI3	AF3: LPTIM1_IN2 AF4: SAI4_CD_B AF6: USART1_CTS/USART1_NSS AF8: TIM8_CH2 AF13: LCD_B6 AF14: PSSI_D14/DCMIPP_D14 AF15: EVENTOUT		VDDIO
U3	GND				
U4	NC				
U20	NC				
U21	NC				
U22	SPI3_SS	PB1	AF1: SPI3_NSS/I2S3_WS AF7: TIM16_CH1N		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF8: TIM20_CH3N AF10: OCTOSPIM_P2_IO1 AF12: FMC_NCE4 AF15: EVENTOUT		
U23	SPI3_SCK	PB7	AF1: SPI3_SCK/I2S3_CK AF3: UART4_TX AF4: SAI4_MCLK_B AF8: TIM20_ETR AF9: TIM12_CH1 AF10: OCTOSPIM_P2_IO7 AF12: FMC_AD10/FMC_D10 AF14: SDMMC3_CDIR AF15: EVENTOUT		VDDIO
V1	USART6_RTS	PG5	AF0: TRACED3 AF1: HDP3 AF3: USART6_RTS/USART6_DE AF7: TIM2_CH3 AF9: I2C6_SDA AF13: LCD_R5 AF14: DCMI_PIXCLK/PSSI_PDCK/DCMIPP_PIXCLK AF15: EVENTOUT		VDDIO
V2	SAI4_FS_B	PI4	AF3: LPTIM1_CH1 AF4: SAI4_FS_B AF8: TIM8_CH3 AF13: LCD_B7 AF14: PSSI_D15/DCMIPP_D15 AF15: EVENTOUT		VDDIO
V3	PA1	PA1	AF2: SPI6_MISO AF4: SAI3_SD_A AF5: USART1_RTS/USART1_DE AF6: USART6_CK		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF7: TIM4_CH2 AF8: I2C4_SDA AF9: I2C6_SDA AF11: LCD_R3 AF13: DCMI_D5/PSSI_D5/DCMIPP_D5 AF14: ETH3_PHY_INTN AF15: EVENTOUT		
V4	NC				
V20	GND				
V21	NC				
V22	SPI3_MOSI	PB8	AF1: SPI3_MOSI/I2S3_SDO AF4: PCIE_CLKREQN AF6: USART1_TX AF7: TIM17_CH1 AF8: TIM20_CH4 AF10: OCTOSPI_P2_NCS1 AF12: FMC_AD12/FMC_D12 AF15: EVENTOUT		VDDIO
V23	GND				
W1	USART6_TX	PF13	AF0: TRACED0 AF1: HDP0 AF2: AUDIOCLK AF3: USART6_TX AF4: SPI2_NSS/I2S2_WS AF5: MDF1_CK17 AF6: USART3_CTS/USART3_NSS AF7: FDCAN3_TX AF8: TIM3_CH3 AF13: LCD_R2 AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
W2	USART6_RX	PF14	AF0: TRACED1 AF1: HDP1 AF3: USART6_RX AF5: MDF1_SDI7 AF6: USART3_RTS/USART3_DE AF7: FDCAN3_RX AF8: TIM3_CH4 AF13: LCD_R3 AF15: EVENTOUT		VDDIO
W3	PG2	PG2	AF1: RTC_REFIN AF2: I2S3_MCK AF3: I3C3_SDA AF4: SAI2_FS_A AF6: USART3_CK AF8: TIM5_CH3 AF9: I2C3_SDA AF10: ETH2_MII_TX_CLK AF11: ETH2_RGMII_CLK125 AF12: FMC_CLK AF13: LCD_HSYNC AF15: EVENTOUT	WKUP5 ADC1_INP2 ADC2_INP2	VDDIO
W4	GND				
W5	NC				
W6	ETH2_TXD0	PC7	AF3: SPI6_MOSI AF4: SAI3_SD_B AF8: TIM8_CH2N AF10: ETH2_MII_TXD0/ETH2_RGMII_TXD0/ETH2_RMII_TXD0 AF11: ETH1_MII_TXD2/ETH1_RGMII_TXD2 AF13: LCD_B4 AF14: DCM1_D1/PSSI_D1/DCMIPP_D1 AF15: EVENTOUT	ADC3_INP9 ADC3_INN5	VDDIO

Pad	ConnectCore MP25 sigal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
W7	ETH2_TXD1	PC8	AF1: LPTIM1_ETR AF3: SPI6_NSS AF4: SAI3_SCK_B AF6: USART6_CTS/USART6_NSS AF8: TIM8_CH2 AF10: ETH2_MII_TXD1/ETH2_RGMII_TXD1/ETH2_RMII_TXD1 AF11: ETH1_MII_TXD3/ETH1_RGMII_TXD3 AF13: LCD_B3 AF14: DCM1_D2/PSSI_D2/DCMIPP_D2 AF15: EVENOUT		VDDIO
W8	ETH2_TXD2	PC9	AF1: MCO1 AF2: SPI3_MISO/I2S3_SDI AF4: SAI2_SCK_A AF7: TIM13_CH1 AF8: TIM8_CH4N AF9: USBH_HS_OVRCUR AF10: ETH2_MII_TXD2/ETH2_RGMII_TXD2 AF11: USB3DR_OVRCUR AF12: FMC_A22 AF13: LCD_G2 AF14: DCM1_D7/PSSI_D7/DCMIPP_D7 AF15: EVENTOUT	ADC1_INP8 ADC1_INN4 ADC2_INP8 ADC2_INN4	VDDIO
W9	ETH2_TXD3	PC10	AF2: SPI3_MOSI/I2S3_SDO AF7: LPTIM4_ETR AF8: TIM8_CH4 AF9: USBH_HS_VBUSEN AF10: ETH2_MII_TXD3/ETH2_RGMII_TXD3 AF11: USB3DR_VBUSEN AF12: FMC_A23 AF13: LCD_G3 AF14: DCM1_D6/PSSI_D6/DCMIPP_D6 AF15: EVENTOUT	ADC1_INP5 ADC2_INP5	VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
W10	ETH2_RXD0	PG0	AF1: LPTIM1_IN1 AF3: I3C3_SDA AF5: MDF1_SD12 AF8: TIM8_CH3N AF9: I2C3_SDA AF10: ETH2_MII_RXD0/ETH2_RGMII_RXD0/ETH2_RMII_RXD0 AF11: ETH1_MII_RXD2/ETH1_RGMII_RXD2 AF13: LCD_G5 AF14: DCM1_D4/PSSI_D4/DCMIPP_D4 AF15: EVENTOUT	ADC1_INP18 ADC1_INN17	VDDIO
W11	ETH2_RXD1	PC12	AF1: LPTIM1_CH2 AF3: I3C3_SCL AF5: MDF1_CK12 AF8: TIM8_CH3 AF9: I2C3_SCL AF10: ETH2_MII_RXD1/ETH2_RGMII_RXD1/ETH2_RMII_RXD1 AF11: ETH1_MII_RXD3/ETH1_RGMII_RXD3 AF13: LCD_G1 AF14: DCM1_D5/PSSI_D5/DCMIPP_D5 AF15: EVENTOUT	ADC1_INP17	VDDIO
W12	ETH2_RXD2	PF9	AF3: SAI3_SD_B AF4: SAI2_SD_A AF5: MDF1_SD15 AF6: UART8_RTS/UART8_DE AF7: TIM2_CH2 AF10: ETH2_MII_RXD2/ETH2_RGMII_RXD2 AF11: ETH2_MDIO AF15: EVENTOUT		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
W13	ETH2_RXD3	PC11	AF1: LPTIM1_CH1 AF2: SPI5_NSS AF4: SAI2_MCLK_A AF5: UART5_RTS/UART5_DE AF6: USART3_RTS/USART3_DE AF7: TIM3_CH1 AF8: TIM5_ETR AF10: ETH2_MII_RXD3/ETH2_RGMII_RXD3 AF12: FMC_NBL1 AF13: LCD_R2 AF14: DCM1_D10/PSSI_D10/DCMIPP_D10 AF15: EVENTOUT	ADC1_INP7 ADC1_INN3 ADC2_INP7 ADC2_INN3 ADC3_INP7 ADC3_INN3	VDDIO
W14	PG1	PG1	AF1: LPTIM1_IN1 AF2: I2S3_MCK AF3: I3C3_SCL AF4: SAI2_SD_A AF5: UART5_CTS AF6: USART3_CTS/USART3_NSS AF8: TIM5_CH4 AF9: I2C3_SCL AF10: ETH2_MII_RX_ER AF11: ETH2_MII_RXD3/ETH2_RGMII_RXD3 AF12: FMC_NBL0 AF13: LCD_VSYNC AF14: DCM1_D11/PSSI_D11/DCMIPP_D11 AF15: EVENTOUT	WKUP3 ADC1_INP6 ADC1_INN2 ADC2_INP6 ADC2_INN2 TAMP_N4	VDDIO/VS
W15	NC				
W16	NC				
W17	3V3				
W18	PG4	PG4	AF2: SPI5_MISO	PVD_IN	VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF3: SAI3_FS_B AF7: LPTIM4_IN1 AF8: TIM8_BKIN AF10: ETH2_PPS_OUT AF11: ETH2_MDC AF12: FMC_A21 AF13: LCD_R7 AF14: DCM1_VSYNC/PSSI_RDY/DCMIPP_VSYNC AF15: EVENTOUT	ADC1_INP4 ADC2_INP4	
W19	PI8/LPO32	PI8	AF15: EVENTOUT	RTC_OUT2/RTC_LSCO TAMP_IN1/TAMP_OUT2	VSW
W20	UCPD_CC1	UCPD1_CC1		UCPD1_CC1	
W21	UCPD_CC2	UCPD1_CC2		UCPD1_CC2	
W22	NC				
W23	PI6	PI6	AF1: MCO1 AF6: USART3_TX AF7: TIM2_ETR AF8: TIM3_CH1 AF13: LCD_VSYNC AF15: EVENTOUT	WKUP4	VDDIO
Y1	USART6_CTS	PF15	AF0: TRACED2 AF1: HDP2 AF2: SPI2_RDY AF3: USART6_CTS/USART6_NSS AF4: SPI2_SCK/I2S2_CK AF6: USART3_CK AF7: TIM2_CH2 AF8: TIM3_ETR		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF9: I2C6_SMBA AF13: LCD_R4 AF15: EVENTOUT		
Y2	PI9	PI9	AF1: SPI7_MOSI AF2: SPI2_MOSI/I2S2_SDO AF4: FDCAN2_TX AF6: UART9_CTS AF8: TIM16_BKIN AF9: SDVSEL2 AF10: FMC_NWAIT AF12: DSI_TE AF13: LCD_B0 AF15: EVENTOUT		VDDIO
Y3	PI10	PI10	AF1: SAI1_SCK_A AF2: SPI1_SCK/I2S1_CK AF3: SPDIFRX1_IN0 AF4: FDCAN2_RX AF5: MDF1_CCK0 AF8: TIM4_CH1 AF9: SDVSEL1 AF12: FMC_AD12/FMC_D12 AF13: DSI_TE AF15: EVENTOUT		VDDIO
Y4	NC				
Y5	NC				
Y6	ETH2_TX_CTL/EN	PC4	AF3: SPI6_MISO AF4: SAI3_FS_B AF10: ETH2_MII_TX_EN/ETH2_RGMII_TX_CTL/ETH2_RMII_TX_EN AF12: ETH1_RGMII_CLK125 AF13: LCD_R0 AF15: EVENTOUT	TAMP_IN1	VDDIO/VSW

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
Y7	GND				
Y8	ETH2_GTX_CLK	PF7	AF2: SPDIFRX1_IN1 AF3: SPI6_SCK AF4: SAI3_SD_A AF7: TIM2_ETR AF10: ETH2_RGMII_GTX_CLK AF11: ETH2_MII_TX_CLK AF13: LCD_R1 AF15: EVENTOUT	TAMP_IN2	VDDIO/VS
Y9	ETH2_RX_CLK	PF6	AF1: RTC_OUT2 AF3: SAI3_MCLK_B AF6: USART6_CK AF7: TIM12_CH1 AF9: I2C3_SMBA AF10: ETH2_MII_RX_CLK/ETH2_RGMII_RX_CLK/ETH2_RMII_REF_CLK AF13: LCD_B0 AF15: EVENTOUT	TAMP_IN5	VDDIO/VS
Y10	GND				
Y11	ETH2_CLK125	PF8	AF1: RTC_REFIN AF3: SAI3_SCK_B AF6: USART3_RX AF7: TIM12_CH2 AF9: ETH1_CLK AF10: ETH2_RGMII_CLK125 AF11: ETH2_MII_RX_ER AF12: ETH2_MII_RX_DV/ETH2_RGMII_RX_CTL/ETH2_RMII_CRS_DV AF13: LCD_G0 AF15: EVENTOUT		VDDIO
Y12	ETH2_RX_CTL/DV	PC3	AF1: LPTIM1_IN2 AF2: SPI3_NSS/I2S3_WS	ADC1_INP12 ADC1_INN10	VDDIO/VS

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF3: SPI6_RDY AF6: USART6_RTS/USART6_DE AF7: FDCAN2_TX AF10: ETH2_MII_RX_DV/ETH2_RGMII_RX_CTL/ETH2_RMII_CRS_DV AF11: ETH1_MII_RX_ER AF13: LCD_G6 AF14: DCM1_D3/PSSI_D3/DCMIPP_D3 AF15: EVENTOUT	ADC2_INP12 ADC2_INN10 ADC3_INP12 ADC3_INN10 TAMP_IN3	
Y13	GND				
Y14	ETH2_MDC	PC6	AF1: RTC_REFIN AF2: SPDIFRX1_IN0 AF5: MDF1_CK11 AF8: TIM8_CH1 AF9: I2C4_SCL AF10: ETH2_MDC AF11: ETH1_MII_CRS AF12: FMC_A24 AF13: ETH1_PHY_INTN AF14: LCD_CLK AF15: EVENTOUT	ADC1_INP9 ADC1_INN5 ADC2_INP9 ADC2_INN5	VDDIO
Y15	ETH2_MDIO	PC5	AF2: SPDIFRX1_IN1 AF5: MDF1_SD11 AF8: TIM8_CH1N AF9: I2C4_SDA AF10: ETH2_MDIO AF11: ETH1_MII_COL AF12: FMC_A25 AF13: ETH1_PPS_OUT AF14: LCD_DE AF15: EVENTOUT	ADC1_INP10 ADC2_INP10 ADC3_INP10 TAMP_IN6	VDDIO/VS
Y16	ETH2_RST	PG6	AF0: TRACED4		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF1: HDP4 AF2: SPI5_SCK AF3: SPI1_SCK/I2S1_CK AF7: TIM2_CH4 AF9: I2C6_SCL AF13: LCD_R6 AF14: DCM1_HSYNC/PSSI_DE/DCMIPP_HSYNC AF15: EVENTOUT		
Y17	PF5	PF5	AF2: SPI6_SCK AF4: SAI3_MCLK_A AF6: USART6_TX AF7: TIM4_CH3 AF8: ETH1_MDIO AF9: ETH1_CLK AF10: ETH2_PHY_INTN AF11: ETH1_PHY_INTN AF13: LCD_B6 AF15: EVENTOUT		VDDIO
Y18	GND				
Y19	ETH2_CLK	PF4	AF1: RTC_OUT2 AF2: SPI6_NSS AF4: SAI3_SCK_A AF6: USART6_RX AF7: TIM4_CH4 AF8: ETH1_MDC AF9: ETH2_CLK AF10: ETH2_PPS_OUT AF11: ETH1_PPS_OUT AF13: LCD_B7 AF15: EVENTOUT		VDDIO
Y20	NC				

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
Y21	NC				
Y22	NC				
Y23	PZ4	PZ4	AF0: DBTRGI AF1: DBTRGO AF2: MCO2 AF3: SPI8_RDY AF4: MDF1_CCK1 AF5: ADF1_CCK1 AF6: LPUART1_RX AF7: LPTIM4_CH1 AF8: I2C8_SCL AF11: I3C4_SCL AF15: EVENTOUT	TAMP_IN5/TAMP_OUT6	VSW
AA1	PD3	PD3	AF1: SAI1_MCLK_A AF2: SPI2_SCK/I2S2_CK AF3: SAI1_D1 AF5: SAI4_MCLK_A AF6: UART7_TX AF7: TIM15_CH1N AF8: TIM1_BKIN2 AF9: SDVSEL2 AF10: OCTOSPIM_P1_NCS1 AF13: PSSI_D15/DCMIPP_D15 AF15: EVENTOUT		VDDIO
AA2	PD4	PD4	AF0: TRACED0 AF1: SPI4_MISO AF2: HDP3 AF3: SAI1_D3 AF4: SAI1_SD_B AF8: TIM1_CH4N AF9: TIM4_CH1 AF10: OCTOSPIM_P1_IO0		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF13: PSSI_D14/DCMIPP_D14 AF15: EVENTOUT		
AA3	NC				
AA4	NC				
AA5	NC				
AA6	NC				
AA7	3V3_RF_EN/PZ6	PZ6	AF0: DBTRGI AF1: DBTRGO AF3: SPI8_NSS AF4: TIM8_CH3 AF5: ADF1_SDI0 AF6: LPUART1_CTS AF7: LPTIM5_OUT AF10: LPTIM4_CH2 AF15: EVENTOUT	TAMP_IN8	VSW
AA8	LDO7				
AA9	SDMMC1_D4	PD11	AF0: TRACED7 AF2: SPI1_SCK/I2S1_CK AF3: SAI1_MCLK_A AF4: UART4_TX AF5: MDF1_CKIO AF6: I2C4_SCL AF8: TIM1_CH1 AF9: SDVSEL1 AF10: OCTOSPIM_P1_IO7 AF11: SDMMC1_D4 AF12: SDMMC1_CKIN AF13: DCMIP_D7/PSSI_D7/DCMIPP_D7 AF15: EVENTOUT		VDDIO
AA10	SDMMC1_D5	PD10	AF0: TRACED6		VDDIO

Pad	ConnectCore MP25 sigal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF1: HDP7 AF3: SAI1_SCK_A AF4: UART4_RX AF5: MDF1_SDI0 AF6: I2C4_SDA AF8: TIM1_CH2 AF9: TIM14_CH1 AF10: OCTOSPIM_P1_IO6 AF11: SDMMC1_D5 AF12: SDMMC1_CDOR AF13: DCMI_D8/PSSI_D8/DCMIPP_D8 AF15: EVENTOUT		
AA11	SDMMC1_D6	PD9	AF0: TRACED5 AF1: HDP6 AF2: SPI1_MOSI/I2S1_SDO AF3: SAI1_SD_A AF4: UART4_RTS/UART4_DE AF5: MDF1_CK11 AF8: TIM1_CH3 AF10: OCTOSPIM_P1_IO5 AF11: SDMMC1_D6 AF12: SDMMC1_D0DIR AF13: DCMI_D9/PSSI_D9/DCMIPP_D9 AF15: EVENTOUT		VDDIO
AA12	SDMMC1_D7	PD8	AF0: TRACED4 AF1: SPI4_RDY AF2: I2S1_MCK AF3: SAI1_FS_A AF4: UART4_CTS AF5: MDF1_SDI1 AF8: TIM1_CH4 AF9: TIM4_ETR AF10: OCTOSPIM_P1_IO4 AF11: SDMMC1_D7		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF12: SDMMC1_D123DIR AF13: DCM1_D10/PSSI_D10/DCMIPP_D10 AF15: EVENTOUT		
AA13	JTRST	JTRST			
AA14	JTMS-SWDIO	JTMS-SWDIO			
AA15	JTDO-TRACESWO	JTDO-TRACESWO			
AA16	GND				
AA17	JTCK-SWCLK	JTCK-SWCLK			
AA18	JTDI	JTDI			
AA19	PZ8	PZ8	AF2: LPTIM3_IN1 AF3: SPI8_MISO AF4: MDF1_SDI5 AF5: ADF1_SDI0 AF6: LPUART1_RX AF7: LPTIM4_CH1 AF8: I2C8_SMBA AF9: LPTIM5_ETR AF15: EVENTOUT		VDDIO
AA20	NC				
AA21	NC				
AA22	GND				
AA23	CSI_D1_N	CSI_D1N			
AB1	PD2	PD2	AF1: HDP2 AF2: SPI1_NSS/I2S1_WS AF3: SAI1_CK1 AF5: SAI4_SCK_A AF6: UART7_CTS		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF7: TIM15_BKIN AF8: TIM1_ETR AF9: FDCAN3_TX AF10: OCTOSPIM_P1_DQS AF11: OCTOSPIM_P1_NCS2 AF13: DCM1_VSYNC/PSSI_RDY/DCMIPP_VSYNC AF15: EVENTOUT		
AB2	PD0	PD0	AF0: TRACECLK AF1: HDP0 AF2: SPI7_RDY AF3: SAI1_D2 AF5: SAI4_FS_A AF6: UART7_RX AF7: TIM15_CH2 AF9: SDVSEL1 AF10: OCTOSPIM_P1_CLK AF13: DCM1_PIXCLK/PSSI_PDCK/DCMIPP_PIXCLK AF15: EVENTOUT		VDDIO
AB3	PD5	PD5	AF0: TRACED1 AF1: SPI4_NSS AF2: HDP4 AF3: SAI1_D4 AF4: SAI1_FS_B AF8: TIM1_CH3N AF9: TIM4_CH2 AF10: OCTOSPIM_P1_IO1 AF13: DCM1_D13/PSSI_D13/DCMIPP_D13 AF15: EVENTOUT		VDDIO
AB4	PD6	PD6	AF0: TRACED2 AF1: SPI4_MOSI AF2: HDP5		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF4: SAI1_SCK_B AF5: MDF1_SDI2 AF8: TIM1_CH2N AF9: TIM4_CH3 AF10: OCTOSPIM_P1_IO2 AF13: DCMI_D12/PSSI_D12/DCMIPP_D12 AF15: EVENTOUT		
AB5	PZ2	PZ2	AF2: LPTIM3_CH1 AF3: SPI8_SCK AF5: ADF1_CCK0 AF6: LPUART1_RTS/LPUART1_DE AF7: LPTIM4_ETR AF8: I2C8_SCL AF11: I3C4_SCL AF15: EVENTOUT	TAMP_IN3/TAMP_OUT7	VSW
AB6	PZ3	PZ3	AF0: DBTRGI AF1: DBTRGO AF2: LPTIM3_ETR AF3: SPI8_NSS AF4: MDF1_SDI5 AF5: ADF1_SDI0 AF6: LPUART1_CTS AF7: LPTIM4_IN1 AF8: I2C8_SDA AF10: LPTIM4_CH2 AF11: I3C4_SDA AF15: EVENTOUT	TAMP_OUT4	VSW
AB7	UART5_CTS	PI5	AF2: SPI5_MOSI AF3: SPI1_MOSI/I2S1_SDO AF5: UART5_CTS AF6: UART9_RX AF8: TIM5_CH2 AF13: LCD_DE		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF14: DCMI_D1/PSSI_D1/DCMIPP_D1 AF15: EVENTOUT		
AB8	UART5_RTS	PG8	AF0: TRACED6 AF1: HDP6 AF2: SPI5_RDY AF3: SPI1_RDY AF4: USART6_CK AF5: UART5_RTS/UART5_DE AF6: UART9_TX AF8: TIM5_CH3 AF13: LCD_G2 AF14: DCMI_D2/PSSI_D2/DCMIPP_D2 AF15: EVENTOUT		VDDIO
AB9	SDMMC3_CK	PB13	AF2: SPI7_SCK AF4: SAI1_SD_B AF5: UART8_RX AF10: SDMMC3_CK AF11: FMC_AD5/MDC_D5 AF12: FMC_AD0/FMC_D0 AF15: EVENTOUT		VDDIO
AB10	GND				
AB11	SDMMC3_D0	PB14	AF2: SPI2_SCK/I2S2_CK AF5: MDF1_CK17 AF6: UART9_RX AF9: TIM4_CH2 AF10: SDMMC3_D0 AF11: FMC_AD7/FMC_D7 AF12: FMC_AD2/FMC_D2 AF15: EVENTOUT		VDDIO
AB12	GND				
AB13	SDMMC3_D2	PB12	AF5: UART8_CTS		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF7: TIM13_CH1 AF9: DSI_TE AF10: SDMMC3_D2 AF11: FMC_NWAIT AF14: DCM1_D12/PSSI_D12/DCMIPP_D12 AF15: EVENTOUT		
AB14	PZ9	PZ9	AF1: MCO2 AF3: SPI8_RDY AF4: MDF1_CK15 AF6: LPUART1_TX AF7: LPTIM4_ETR AF8: I2C8_SDA AF10: LPTIM3_CH2 AF11: I3C4_SDA AF15: EVENTOUT		VDDIO
AB15	PG3	PG3	AF1: LPTIM1_ETR AF2: SPI5_MOSI AF3: UART8_TX AF4: SAI2_FS_B AF7: TIM3_CH3 AF8: TIM8_ETR AF9: ETH2_CLK AF10: ETH2_PHY_INTN AF12: FMC_A19 AF13: LCD_R5 AF14: DCM1_PIXCLK/PSSI_PDCK/DCMIPP_PIXCLK AF15: EVENTOUT	WKUP6 ADC1_INP3 ADC2_INP3 ADC3_INP3 TAMP_IN7	VDDIO/VSW
AB16	I2C2_SCL	PB5	AF2: I2S2_MCK AF3: UART4_RTS/UART4_DE AF4: SAI4_SD_B AF5: MDF1_CK14 AF8: TIM20_CH1		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF9: I2C2_SCL AF10: OCTOSPIM_P2_IO5 AF12: FMC_AD8/FMC_D8 AF13: I3C2_SCL AF14: SDMMC3_D123DIR AF15: EVENTOUT		
AB17	PF10	PF10	AF1: MCO2 AF2: SPI3_RDY AF4: SAI2_MCLK_A AF5: MDF1_CK16 AF6: UART8_TX AF7: TIM2_CH3 AF10: ETH2_MII_TXD2/ETH2_RGMII_TXD2 AF15: EVENTOUT	ADC3_INP2	VDDIO
AB18	PZ7	PZ7	AF3: SPI8_MOSI AF4: MDF1_CCK1 AF5: ADF1_CCK1 AF6: LPUART1_TX AF7: LPTIM5_IN1 AF10: LPTIM3_CH2 AF15: EVENTOUT		VDDIO
AB19	PG7	PG7	AF0: TRACED5 AF1: HDP5 AF2: SPI5_NSS AF3: SPI1_NSS/I2S1_WS AF6: UART9_CTS AF8: TIM5_ETR AF13: LCD_R7 AF14: DCM1_VSYNC/PSSI_RDY/DCMIPP_VSYNC AF15: EVENTOUT		VDDIO
AB20	GND				

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
AB21	NC				
AB22	NC				
AB23	CSI_D1_P	CSI_D1P			
AC1	GND				
AC2	ANA0	ANA0		ADC1_INP0 ADC1_INN1 ADC2_INP0 ADC2_INN1 ADC3_INP0 ADC3_INN1	
AC3	ANA1	ANA1		ADC1_INP1 ADC2_INP1 ADC3_INP1	
AC4	VREF+	VREF+			
AC5	PD7	PD7	AF0: TRACED3 AF1: SPI4_SCK AF2: SPI1_RDY AF4: SAI1_MCLK_B AF5: MDF1_CK12 AF8: TIM1_CH1N AF9: TIM4_CH4 AF10: OCTOSPIM_P1_IO3 AF13: DCM1_D11/PSSI_D11/DCMIPP_D11 AF15: EVENTOUT		VDDIO
AC6	PZ0	PZ0	AF2: LPTIM3_IN1 AF3: SPI8_MOSI AF4: TIM8_CH1 AF6: LPUART1_TX AF7: LPTIM5_OUT AF8: I2C8_SDA	CPU3_SWDIO TAMP_OUT3	VSW

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF10: LPTIM3_CH2 AF11: I3C4_SDA AF15: EVENTOUT		
AC7	PZ1	PZ1	AF2: LPTIM3_CH1 AF3: SPI8_MISO AF4: TIM8_CH2 AF6: LPUART1_RX AF7: LPTIM5_ETR AF8: I2C8_SCL AF9: I2C8_SMBA AF11: I3C4_SCL AF15: EVENTOUT	CPU3_SWCLK TAMP_OUT5	VSW
AC8	UART5_TX	PG9	AF0: TRACED7 AF5: UART5_TX AF8: TIM5_CH4 AF13: LCD_G3 AF14: DCMI_D3/PSSI_D3/DCMIPP_D3 AF15: EVENTOUT		VDDIO
AC9	UART5_RX	PG10	AF0: TRACED8 AF1: HDP0 AF5: UART5_RX AF8: TIM8_CH4N AF13: LCD_G4 AF14: DCMI_D4/PSSI_D4/DCMIPP_D4 AF15: EVENTOUT		VDDIO
AC10	SDMMC3_CMD	PD12	AF1: SPI7_MISO AF2: SPI2_MISO/I2S2_SDI AF3: SPDIFRX1_IN2 AF5: UART8_RTS/UART8_DE AF9: TIM4_ETR AF10: SDMMC3_CMD AF11: FMC_AD6/FMC_D6		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF12: FMC_AD1/FMC_D1 AF15: EVENTOUT		
AC11	SDMMC3_D1	PD13	AF2: SPI2_NSS/I2S2_WS AF5: MDF1_SDI7 AF6: UART9_TX AF9: TIM4_CH4 AF10: SDMMC3_D1 AF11: FMC_AD11/FMC_D11 AF12: FMC_NWE AF15: EVENTOUT		VDDIO
AC12	SDMMC3_D3	PI11	AF2: I2S2_MCK AF5: UART8_TX AF6: UART9_RTS/UART9_DE AF9: TIM4_CH3 AF10: SDMMC3_D3 AF11: FMC_AD15/FMC_D15 AF15: EVENTOUT		VDDIO
AC13	LDO8				
AC14	FDCAN1_TX	PG11	AF0: TRACED9 AF1: HDP1 AF2: SPI7_MOSI AF7: FDCAN1_TX AF8: TIM8_CH4 AF13: LCD_G5 AF14: DCM1_D5/PSSI_D5/DCMIPP_D5 AF15: EVENTOUT		VDDIO
AC15	FDCAN1_RX	PG12	AF0: TRACED10 AF1: HDP2 AF2: SPI7_MISO AF7: FDCAN1_RX AF8: TIM8_CH1N AF13: LCD_G6		VDDIO

Pad	ConnectCore MP25 signal name	STM32MP2 pad name	Alternate functions	Additional functions	Power group
			AF14: DCMI_D6/PSSI_D6/DCMIPP_D6 AF15: EVENTOUT		
AC16	I2C2_SDA	PB4	AF2: SPI2_RDY AF3: UART4_CTS AF4: SAI4_FS_B AF5: MDF1_SDI4 AF6: TIM14_CH1 AF8: TIM20_CH2 AF9: I2C2_SDA AF10: OCTOSPIM_P2_IO4 AF13: I3C2_SDA AF15: EVENTOUT		VDDIO
AC17	PF11	PF11	AF1: MCO1 AF2: SPDIFRX1_IN0 AF3: SPI6_RDY AF4: SAI2_SCK_A AF5: MDF1_SDI6 AF6: UART8_RX AF7: TIM2_CH4 AF10: ETH2_MII_TXD3/ETH2_RGMII_TXD3 AF15: EVENTOUT	ADC3_INP6 ADC3_INN2	VDDIO
AC18	GND				
AC19	CSI_CLK_N	CSI_CKN			
AC20	CSI_CLK_P	CSI_CKP			
AC21	CSI_D0_N	CSI_D0N			
AC22	CSI_D0_P	CSI_D0P			
AC23	GND				

Module specifications

The following sections describe the specifications for the ConnectCore MP25 SOM.

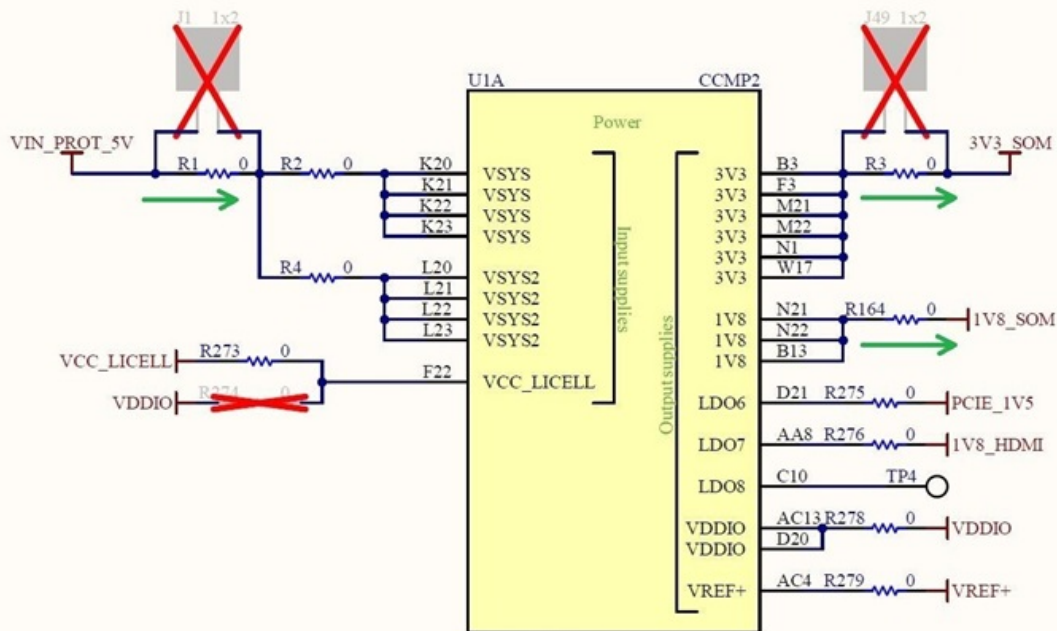
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Power consumption

This section contains information about the power consumption of the ConnectCore MP25 system-on-module. All presented results, unless otherwise noted, were measured with ConnectCore MP25 variant -01 on a ConnectCore MP25 DVK at ambient temperature (25°C).

The power consumption in the ConnectCore MP25 DVK is calculated as follows:

$$\text{Module Power consumption (W)} = I_{R1} * 5V - I_{R3} * 3.3V - I_{R164} * 1.8V$$



Note These power consumption numbers should be considered guidelines only, never as fixed or absolute values. Actual values will depend entirely upon individual setup and system application.

Power consumption use cases

The power consumption of the ConnectCore MP25 system-on-module was evaluated in the following use cases:

Standby

In this mode, the system suspends to RAM and operation can be resumed without performing a new boot cycle. RAM memory is in self-refresh.

Note that in order to achieve the deepest standby power mode it is necessary to disable all wake-up sources except the internal RTC.

System IDLE

In this use case, the system is running Digi Embedded Yocto.

RTC

System on RTC (Real-time clock) mode keeping time of the system, powered from a coin cell with no other power supply attached.

Results

Use case	Power consumption	Notes
Standby	TBD	
IDLE	TBD	
RTC	TBD	

Mechanical specifications

This section provides mechanical dimensions and host PCB footprint guidance for the Digi SMTplus® form factor of the ConnectCore MP25 module.

Note See the ConnectCore MP25 product page for mechanical design documents, drawings, and other resources.

Host PCB footprint and cutout

Host PCBs must have a cutout to accommodate the components on the bottom side of the module:

- Cutout tolerances: +/- 0.15 mm
- Corner radius: 0.5 mm

Label

The MAC address and serial number of the SOM are encoded in the data matrix on the SOM label.

Environmental specifications

Operating temperature: -40 to 85 C.



CAUTION! Your final product may require additional thermal management such as passive (heatsink/spreader) or active (airflow) cooling to achieve the maximum operating temperature without exceeding the processor junction temp limit.

Socket options

For testing, prototyping, and other primarily development-related purposes, Digi International and E-tec Interconnect AG have developed sockets allowing the easy insertion and removal of modules in a carrier board design.

All drawings, user instructions, schematics and PCB footprints are posted on the ConnectCore MP25 technical support website.

Note The ConnectCore MP25 Development Board (Digi P/N CC-WMP255-KIT) has been designed to support a LPF334-129M-23ACEW55L socket, and can be used as a reference design.

All sockets are sold and built by [E-tec Interconnect AG](#). The table below provides an overview of the available part numbers.

Socket model	E-tec part number
ConnectCore MP25	LPF334-129M-23ACEW55L

Note Please direct all socket-related purchase inquiries to E-tec Interconnect AG (info@e-tec.com).
